Joint IEEE 802.1 Nendica / IEEE 802.3 NEA Ad hoc Meeting
20 April 2022 Electronic Session

Approved Meeting Minutes, prepared by John D'Ambrosia
Session called to order at 12:00 pm ET (all times ET), 20 April 2022
Meeting called to order by Roger Marks, IEEE 802.1 Nendica Ad hoc Chair

Chair gave meeting introduction.
Chair identified John D'Ambrosia as recording secretary for meeting.

Presentation #1   **Meeting Introduction**
Presenters   Roger Marks
URL   https://www.ieee802.org/1/files/public/templates/admin-prePAR-intro-0721-v01.pdf

Chair reviewed meeting decorum. See Slide #3.
Chair reviewed IMAT attendance. See Slide #4.
Chair reviewed electronic meeting guidelines. See Slide #5.
Chair reviewed IEEE SA Pre-PAR Patent Policy. See Slide #7.
Chair reviewed IEEE SA Copyright and Participation Policies.

Agenda – chair asked if there were any comments on the agenda. There were none. Chair asked if there were any objections to the agenda, there were none, and the agenda was considered approved.

Presentation #2   **IEEE 802.3 NEA Ad hoc Information**
Presenters   Jon D'Ambrosia presented for Jon Lewis
URL   https://mentor.ieee.org/802.1/dcn/22/1-22-0018-00-ICne-ieee-802-3-nea-ad-hoc-information.pdf

There were questions and discussion regarding the request of a CFI in 802.3.

Presentation #3   **Joint CTF Ad hoc: Nendica background**
Presenters   Roger Marks
URL   https://mentor.ieee.org/802.1/documents?is_group=ICne&is_year=2022&is_dcn=0016

Presentation #4   **Cut-Through Forwarding in Bridges and Bridged Networks [CTF]**
Presenters   Johannes Sprecht
URL   https://mentor.ieee.org/802.1/documents?is_group=ICne&is_year=2022&is_dcn=0017

It was noted that there may be some missing presentations from the NEA Archive. D'Ambrosia noted he would review the NEA archive and update as appropriate. During the call D'Ambrosia noted the following in the Chat window –
        "the noted NEA Presentations occurred during the Jan 2018 Interim and Mar 2018 Plenary. See
        https://www.ieee802.org/3/ad_hoc/ngrates/public/18_01/index.html and
        https://www.ieee802.org/3/ad_hoc/ngrates/public/18_03/index.html."

There was discussion regarding steps forward. A request was made for someone from 802.3 to make a presentation that would explain the major technical concerns that IEEE 802.3 had expressed at the March 2022 Plenary regarding the CSD draft.

Meeting adjourned at 1:00pm.

Attendance (Per 802.1 IMAT)

Chen, Feng	Siemens AG
Didde, Stephen	Keysight Technologies
Ellegaard, Lars	Microchip Technology, Inc.
Farkas, Janos	Ericsson AB
Finn, Norman	Huawei Technologies Co., Ltd
Gravel, Mark	Hewlett Packard Enterprise
Hernandez, Marco	National Institute of Information and Communications Technology (NICT)
Kehrer, Stephan	Hirschmann Automation and Control, Inc.
Marks, Roger	EthAirNet Associates; Huawei
Nakano, Hiroki	CAHI Corporation; Kyoto University; National Institute of Information and Communications Technology (NICT)
Ofelt, David	Juniper Networks, Inc.
Parsons, Glenn	Ericsson AB
Proell, Dieter	Siemens AG
Rouyer, Jessy	Nokia
Specht, Johannes	Self; Analog Devices, Inc.; Mitsubishi Electric Corporation; Phoenix Contact GmbH & Co. KG; PROFIBUS Nutzerorganisation e.V.; Siemens AG; Texas Instruments, Inc.
Turner, Max	Ethernovia, BMW, Ruetz System Solutions
Weber, Karl	Beckhoff Automation
Woods, Jordon	Analog Devices Inc.

Attendance (Per 802.3 IMAT)

Brandt, David	Rockwell Automation
Carty, Clark	Cisco Systems, Inc.
Castro, Jose	Panduit Corp.
Chang, Yongmao	Source Photonics
D'Ambrosia, John	Futurewei Technologies, U.S. Subsidiary of Huawei
Grow, Robert	RMG Consulting, KDPOF
Hajduczenia, Marek	Charter Communications
Jackson, Kenneth	Sumitomo Electric Industries, LTD
Jones, Chad	Cisco Systems, Inc.
Jones, Peter	Cisco Systems, Inc.
Law, David	Hewlett Packard Enterprise
Lewis, Jon	Dell Technologies
Ofelt, David	Juniper Networks, Inc.
Pandey, Sujan	Huawei Technologies (Netherlands) B.V.
Pearn, Richie	NXP Semiconductors
Ran, Adee	Cisco Systems, Inc.
Shah, Anup	Siemens EDA
Sun, Yi	OFS
Tse, Richard	Microchip Technology, Inc.
Vanderlaan, Paul	UL LLC
Wang, Xinyuan	Huawei Technologies Co., Ltd
Young, James	CommScope
Zimmerman, George	CME Consulting/ADI, APL Group, CommScope, Cisco Systems, Marvell, and SenTekse

Andy
Brett McClellan - Marvell
Brian Murray - Analog Devices
Bulent Kose - Panduit Corp.
Call-in User_3
Cedric Lam [Google]
David Malicoat Independent/Senko
Ed Ulrichs Intel
Frank Chang
Greg D Le Cheminant Keysight Technologies
Jason Potterf
Junich Sugiyama [Fujitsu]
Li Rirxin Huawei
Mario Milicevic [MaxLinear]
Mark Bordogna Intel
Massimo Sorbara [Globalfoundries]
Michal Brychta Analog Devices
Nathan Tracy TE
Ramana Murty [Broadcom]
Rudy Belliardi Schneider Electric
Ryan Latchman MACOM
Scott Sommers Molex LLC
Shimon Muller [Enfabrica]
Stephen Haddock Haddock LLC
Sujan Pandey Huawei
Tomas Maj